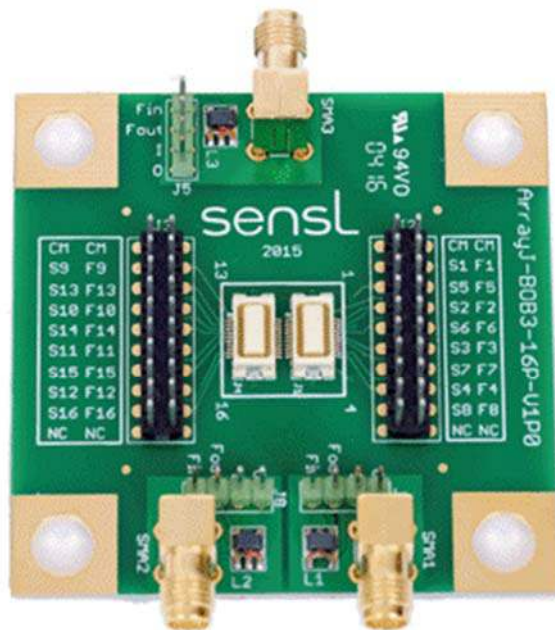




## ARRAYJ-BOB3-16P-GEVK: J-Array 3mm 4x4 BOB

The ArrayJ-BOB3-16P is an evaluation board allowing easy access to the signals from a SensL ArrayJ-300XX-16P, 3 mm 4 x 4 SiPM array.

The Breakout Board has two HIROSE 20-way connectors DF17(3.0)-20DS-0.5v(57). These connectors mate with the Samtec DF17(2.0)-20DP-0.5v(57) board-to-board connectors on the array. All signals on the array are routed via the mating connectors to header pins. These pins are formed by two 20-way (10 x 2 row) 2.54 mm pitch headers. Three SMA connectors and Balun transformers are provided with 4-pin headers to allow any signal to be connected directly to the SMA or via the transformer using jumper wires. Four 7 mm holes are aligned on a 25 mm grid to allow mounting of the board on an optical breadboard.



### Evaluation/Development Tool Information

Product	Status	Compliance	Short Description	Parts Used
ARRAYJ-BOB3-16P-GEVK	Active		J-Array 3mm 4x4 BOB	ARRAYJ-30020-16P-PCB , ARRAYJ-30035-16P-PCB